

Amendment to the Claims:

Please cancel claims 59-62 and amend claim 58.

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

1. (Previously presented) A removable expansion module for a portable host, referred to as the first-level module, for engagement with a portable host when inserted into an opening in the host, the first-level module comprising:

an expansion module frame and a PCB;

a host-interconnect for coupling with the host when the first-level module is inserted in the opening in the host;

an I/O interconnect for coupling with an external I/O device;

I/O adapter circuitry for the I/O device;

a second-level interconnect for coupling with a second-level expansion module;

and

second-level adapter circuitry coupled to the second-level interconnect;

wherein the first-level module has an opening sized and positioned to allow insertion of the second-level expansion module into the opening so as to engage the second-level interconnect while the first-level module is engaged with the portable host, and to allow withdrawal of the second-level expansion module from the opening so as to disengage from the second-level interconnect while the first-level module is engaged with the portable host.

2. (Original) The module of claim 1, wherein the module is a CompactFlash module.

3. (Previously presented) The module of claim 1, wherein:

the second-level expansion module is a removable memory;

the second-level interconnect is compatible with a MultiMediaModule; and